TDI Camera C10000-801

Time Delay Integration Camera



The C10000-801 TDI camera is useful for a wide range of imaging applications requiring high speed operation with high sensitivity simultaneously. TDI is a special image acquisition method that has been used extensively in machine vision applications for industrial inspection. TDI imaging is appropriate for applications where it is desired to record a linear process over time, or where the aspect ratio of the subject being imaged is significantly asymmetric. TDI is particularly useful for low light level scanning applications for which a typical line scan camera can not make a useful image. Also, frame readout mode is available for easy focusing.

FEATURES

- High resolution / high sensitivity (Horizontal spatial resolution with 128(V) TDI stages) - 2048(H) × 128 (V), 4 TAP
- Line rate up to 50 kHz
- High speed imaging combined with high sensitivity and low noise
- Great spectral response for UV-NIR with back thinned CCD
- 100× anti-blooming with lateral overflow drain
- Dynamic range of 1600 : 1
- 12 bit / 8 bit selectable A/D converter
- Bidirectional scanning operation
- Frame readout mode for easy focusing
- Real time shading correction with internal DSP

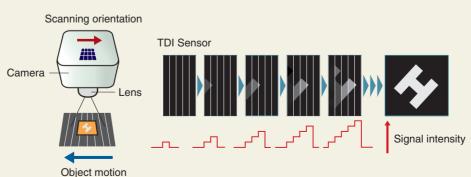
APPLICATIONS

- High speed imaging for low light applications i.e. fluorescence imaging
- Electronics manufacturing and inspection
- Semiconductor inspection
- High speed scanning for a large size sample i.e. flat panel displays

OPERATING PRINCIPLE OF TDI

TDI (Time Delay Integration):

Time Delay Integration is a scanning technology in which a frame transfer device produces a continuous video image of a moving object by means of a stack of linear arrays aligned with and synchronized to the motion of the object to be imaged in such a way that, as the image moves from one line to the next, the integrated charge moves along with it, providing higher resolution at lower light levels than is possible with a line-scan camera.





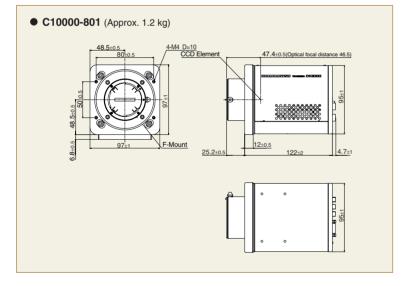
SPECIFICATIONS

Type number	C10000-801
Pixel number	2048 (H) × 128 (V)
Device structure	Back thinned type
Cell size	12 μm(H) × 12 μm(V)
Effective area	24.58 mm(H) × 1.536 mm(V)
Readout mode	TDI readout mode or frame readout mode*1
TDI transfer direction	Bidirectional transfer
TDI output channel	4 TAP (512 × 4)
Anti-blooming	Lateral overflow drain (100×)
TDI pixel clock rate	30 MHz
TDI line rate	0.45 kHz to 50 kHz
TDI line rate control	Internal setting by serial command*2 / External trigger
Full-well capacity (typ.)	80 000 electrons
Readout noise (typ.)	50 electrons rms
Dynamic range (typ.)	1600 : 1
Binning	2×2 , 4×4
Analog enhancement gain	1 time to 5 times (16 steps)
A/D converter	12 bit / 8 bit * ³
Image processing	Real-time shading correction
Interface	Base Configuration
Camera control	Serial control in Camera Link
Camera output clock	60 MHz
Camera output channel	2 TAP (1024 × 2)
Camera Link connector	Mini-Camera Link (SDR) × 1
Lens mount	F-mount
Power requirements	AC100 V to AC240 V, 50 Hz/60 Hz
Power consumption	Approx. 55 VA
Ambient storage temperature	-10 °C to +50 °C
Ambient operating temperature	0 °C to +40 °C
Ambient operating humidity	70 % max. (with no condensation)

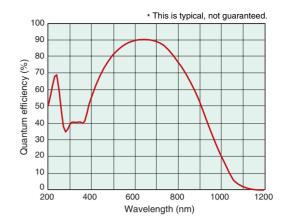
*1 Frame readout mode is useful for easy focusing, but it is not suitable for measurement. Please consult with our sales office for details.

- *2 Internal TDI line rate is set by 33 ns step.
- *3 Selectable by serial command

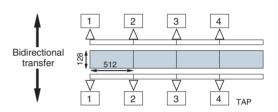
DIMENSIONAL OUTLINES (Unit: mm)



SPECTRAL RESPONSE



TDI SENSOR STRUCTURE



OPTIONS

- SMA-BNC External trigger cable A12106-05
- SMA-SMA External trigger cable A12107-05
- Camera Link cable (5 m) A10514-05

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